



Product Change Notification / SYST-24WSSA487

Date:

25-Nov-2021

Product Category:

32-bit Microcontrollers

PCN Type:

Document Change

Notification Subject:

ERRATA - SAM D20 Family Silicon Errata

Affected CPNs:

[SYST-24WSSA487_Affected_CPN_11252021.pdf](#)

[SYST-24WSSA487_Affected_CPN_11252021.csv](#)

Notification Text:

SYST-24WSSA487

Microchip has released a new Product Documents for the SAM D20 Family Silicon Errata of devices. If you are using one of these devices please read the document located at [SAM D20 Family Silicon Errata](#).

Notification Status: Final

Description of Change:

1. The SPI and I2C standards use the terminology "Master" and "Slave". The equivalent Microchip terminology, "Host" and "Client", is used in this document. This terminology has been updated throughout this document for this revision.

2. Added the following two errata issues: BOD: 1.4.3 Hysteresis

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

Change Implementation Status: Complete

Date Document Changes Effective: 25 Nov 2021

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachments:

[SAM D20 Family Silicon Errata](#)

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Affected Catalog Part Numbers (CPN)

ATSAMD20E16B-MZ
ATSAMD20E15B-MZ
ATSAMD20E16B-MZVAO
ATSAMD20E16B-AZ
ATSAMD20E15B-AZ
ATSAMD20G16B-MZ
ATSAMD20G15B-MZ
ATSAMD20J16B-AZ
ATSAMD20J15B-AZ
ATSAMD20G16B-AZ
ATSAMD20G15B-AZ
ATSAMD20E16B-MU
ATSAMD20E15B-MU
ATSAMD20E14B-MU
ATSAMD20G16B-MU
ATSAMD20G15B-MU
ATSAMD20G14B-MU
ATSAMD20E16B-AU
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ATSAMD20E14B-AU
ATSAMD20J16B-MU
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ATSAMD20G14A-AUTA2
ATSAMD20G18A-AUTA3

SAM D20 Family Silicon Errata and Data Sheet Clarification

SAM D20 Family

The SAM D20 family of devices that you have received conform functionally to the current Device Data Sheet (DS60001504F), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in [Table 1](#) and [Table 2](#).

The errata described in this document will be addressed in future revisions of the SAM D20 family silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current.

Data Sheet clarifications and corrections (if applicable) are located in [2. Data Sheet Clarifications](#), following the discussion of silicon issues.

Table 1. SAM D20 Family Silicon Device Identification (Device Variant A)

Part Number	Device ID (DID[31:0])	Revision (DID.Revision[3:0])				
		B(1)	C	D	E	G
ATSAMD20J16A	0x10001x02	0x1	0x2	0x3	0x4	N/A
ATSAMD20J15A	0x10001x03					
ATSAMD20J14A	0x10001x04					
ATSAMD20G16A	0x10001x07					
ATSAMD20G15A	0x10001x08					
ATSAMD20G14A	0x10001x09					
ATSAMD20E16A	0x10001x0C					
ATSAMD20E15A	0x10001x0D					
ATSAMD20E14A	0x10001x0E					
ATSAMD20J18A	0x10001x00					
ATSAMD20J17A	0x10001x01					
ATSAMD20G18A	0x10001x05					
ATSAMD20G17A	0x10001x06					
ATSAMD20E18A	0x10001x0A					
ATSAMD20E17A	0x10001x0B					
ATSAMD20G18A-U	0x10001x10					
ATSAMD20G17A-U	0x10001x11					

Note:

1. Revision B and C parts contain die number '0' (that is, for revision B and C, DID.DIE[3:0] = 0).

Table 2. SAM D20 Family Silicon Device Identification (Device Variant B)

Part Number	Device ID (DID[31:0])	Revision (DID.Revision[3:0])				
		B	C	D	E	G
ATSAMD20E14B	0x10001x0E	N/A	N/A	N/A	N/A	0x6
ATSAMD20E15B	0x10001x0D					
ATSAMD20E16B	0x10001x0C					
ATSAMD20G14B	0x10001x09					
ATSAMD20G15B	0x10001x08					
ATSAMD20G16B	0x10001x07					
ATSAMD20J14B	0x10001x04					
ATSAMD20J15B	0x10001x03					
ATSAMD20J16B	0x10001x02					
ATSAMD20E15B-U	0x10001x10					
ATSAMD20E16B-U	0x10001x0F					

Note: Refer to the “Device Service Unit” chapter in the current device data sheet (DS60001504F) for a detailed information on Device Identification and Revision IDs for your specific device.

Silicon Errata Summary

Module	Feature	Errata Number	Summary	Affected Silicon Revisions				
				B	C	D	E	G
XOSC32K	Amplitude Control	1.1.1	The automatic amplitude control of the XOSC32K does not work.	X	X	X	X	X
DFLL48M	DFLL Clock	1.2.1	The DFLL clock must be requested before being configured otherwise a write access to a DFLL register can freeze the device.	X	X	X	X	X
DFLL48M	Calibration Bits	1.2.2	Changing the DFLLVAL.FINE calibration bits of the DFLL48M Digital Frequency Locked Loop might result in a short output frequency overshoot.	X	X			
DFLL48M	Firmware Writes	1.2.3	If the firmware writes to the DFLLMUL.MUL register in the same cycle as the Closed-Loop mode tries to update it, the fine calibration will first be reset to midpoint and then incremented/decremented by the Closed-Loop mode.	X	X			
DFLL48M	Locking Sequence	1.2.4	If the DFLL48M reaches the maximum or minimum COARSE or FINE calibration values during the locking sequence, an out of bounds interrupt will be generated.	X	X	X	X	X
ADC	ADC Samples	1.3.1	The automatic right shift of the result when accumulating/averaging ADC samples does not work.	X	X			
ADC	Bus Clock Frequency	1.3.2	When the ADC bus clock frequency (CLK_ADC_APB) is smaller than the ADC asynchronous clock frequency (GCLK_ADC), issuing an ADC SWRST (ADC.CTRLA.SWRST) will lock up the ADC with the SYNCBUSY(ADC.STATUS.SYNCBUSY) flag always set.	X	X			
BOD	BOD33 HYST Bit	1.4.1	The BOD33 HYST bit is not updated from NVM user row at power on. The reset value of this bit is zero.	X	X			
BOD	BOD12 HYST Bit	1.4.2	The BOD12 HYST bit is not updated from NVM user row at power on. The reset value of this bit is zero.	X	X			
BOD	Hysteresis	1.4.3	BOD33 hysteresis failure upon reset while in the hysteresis window.	X	X	X	X	X

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Module	Feature	Errata Number	Summary	Affected Silicon Revisions				
				B	C	D	E	G
Device	Maximum Toggle Frequency	1.5.1	Maximum toggle frequency on all pins in worst case operating condition is 8 MHz.	X	X			
Device	APB Clock	1.5.2	If APB clock is stopped and GCLK clock is running, APB read access to read-synchronized registers will freeze the system.	X	X	X	X	X
Device	VDDIN	1.5.3	When VDDIN is lower than the POR threshold during power rise or fall, an internal pull-up resistor is enabled on pins with PTC functionality (see PORT Function Multiplexing).	X	X	X		
Device	Missing Bit Groups	1.5.4	The DFLLVAL.COARSE, DFLLVAL.FINE, DFLLMUL.CSTEP and DFLLMUL.FSTEP bit groups are not correctly located in the register map.	X	X			
Device	Standby Mode	1.5.5	With default bit and register settings, the device does not work as specified in Standby mode if load current exceeds 100 µA.	X	X			
Device	Temperature Sensor	1.5.6	The temperature sensor is not accurate.	X	X			
Device	External XOSC32K State	1.5.7	If the external XOSC32K is broken, neither the external pin RST nor the GCLK software reset can reset the GCLK generators using XOSC32K as source clock.	X	X	X	X	X
Device	Voltage Regulator	1.5.8	The voltage regulator in Low-Power mode is not functional at temperature above 85°C.			X	X	
Device	Standby Sleep Mode	1.5.9	Digital pin outputs from Timer/Counters, AC (Analog Comparator), GCLK (Generic Clock Controller), and SERCOM (I ² C and SPI) do not change values during Standby Sleep mode.			X		
Device	PORT Output Driver Strength Feature	1.5.10	The PORT output driver strength feature is not available.	X	X			
Device	Clock Failure Detection	1.5.11	After a clock failure detection (INTFLAG.CFD = 1), if INTFLAG.CFD is cleared while the clock is still broken, the system is stuck.	X	X	X	X	X
Device	Clock Failure Detection for External OSC	1.5.12	Clock Failure detection for external OSC does not work in Standby mode.	X	X	X	X	X
Device	Digital Output Control in Standby Sleep Mode	1.5.13	Do not enable Timers/Counters, AC (Analog Comparator), GCLK (Generic Clock Controller), and SERCOM (I ² C and SPI) to control Digital outputs in Standby Sleep mode.	X	X			
Device	Invalid DFLL Calibration Values	1.5.14	The values stored in the NVM software calibration area for the DFLL calibration are not valid.	X	X			
Device	Sleep Modes	1.5.15	In Standby, Idle1 and Idle2 Sleep modes, the device might not wake up from sleep.	X	X	X		
Device	Single-Shot mode at 105°C	1.5.16	In Single-Shot mode and at 105°C and above, the ADC conversions have linearity errors.			X	X	X
Device	I ² C Client Mode	1.5.17	In I ² C Client mode, writing the CTRLB register when in the AMATCH or DRDY interrupt service routines can cause the state machine to reset.			X	X	
Device	NVM User Row Mapping	1.5.18	In the table "NVM User Row Mapping", bits 40 and 41 default values on silicon are not as specified in the device data sheet.			X	X	X
Device	WDT Window Bits	1.5.19	In the table "NVM User Row Mapping", the WDT Window bit field default value on silicon is not as specified in the device data sheet.	X	X	X	X	X
Device	Incorrect SYSTICK Calibration Value	1.5.20	The SYSTICK calibration value is incorrect.	X	X	X	X	X
Device	Standby Entry	1.5.21	Potential device lockup upon standby entry when SYSTICK interrupt is enabled, all revisions are impacted.	X	X	X	X	X

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Module	Feature	Errata Number	Summary	Affected Silicon Revisions				
				B	C	D	E	G
DSU	Debugging	1.6.1	If a debugger has issued a DSU Cold-Plugging procedure and then released the CPU from the resulting "CPU Reset Extension", the CPU will be held in "CPU Reset Extension" after any upcoming reset event.	X	X	X		
DSU	Non-functional MBIST "Pause-on-Error" Feature	1.6.2	The MBIST "Pause-on-Error" feature is not functional on this device.	X	X	X	X	X
DAC	Standby Sleep Mode	1.7.1	When DAC.CTRLA.RUNSTDBY = 0 and DATABUF is written (not empty), if the device goes to Standby Sleep mode before a Start Conversion event, DAC.INTFLAG.EMPTY will be set after exit from Sleep mode.	X	X	X	X	X
EIC	Edge Configuration	1.8.1	When the EIC is configured to generate an interrupt on a low level or rising edge or both edges (CONFIGn.SENSEx) with the filter enabled (CONFIGn.FILTENx), a spurious flag might appear for the dedicated pin on the INTFLAG.EXTINT[x] register as soon as the EIC is enabled using the CTRLA ENABLE bit.	X	X	X	X	X
EVSYS	Channel Generator Change	1.9.1	Changing the selected generator of a channel can trigger a spurious interrupt/event.	X	X			
EVSYS	Overflow Condition	1.9.2	Using synchronous or resynchronized paths, some channels (0,3,6,7) detect an overrun on every event even if no overrun condition is present.	X	X			
GCLK	GCLK Lock State	1.10.1	When a GCLK is locked and the generator used by the locked GCLK is not GCLK generator 1, issuing a GCLK software reset will lock up the GCLK with the SYNCBUSY flag always set.	X	X			
GCLK	Division Factor	1.10.2	The GCLK Generator clock is stuck when disabling the generator and changing the division factor from '1' to a different value while the GCLK generator is set as output.	X	X			
GCLK	Division Factor	1.10.3	When the GCLK generator is enabled (GENCTRL.GENEN = 1), set as output (GENCTRL.OE = 1) and use a division factor of one (GENDIV.DIV = 1 or 0 and GENCTRL.DIVSEL= 0), the GCLK_IO might not be set to the configured GENCTRL.OOV value after disabling the GCLK generator (GENCTRL.GENEN=0).	X	X			
PORT	PORT Read and Write	1.11.1	PORT read/write attempts on non-implemented registers, do not generate a PAC protection error.	X	X	X	X	X
NVMCTRL	Erase or Write	1.12.1	When NVMCTRL issues either erase or write commands and the NVMCTRL cache is not in LOW_POWER mode, CPU hardfault exception may occur.	X	X			
NVMCTRL	Cache Read Mode	1.12.2	When Cache Read mode is set to deterministic (READMODE = 2), setting CACHEDIS=1 does not lead to 0 wait states on Flash access.	X	X			
NVMCTRL	EEPROM Emulation Area Configuration	1.12.3	When the device is secured and EEPROM emulation area configured to none, the CRC32 is not executed on the entire Flash area but up to the on-chip Flash size minus half a row.	X	X	X		
NVMCTRL	Default MANW Value	1.12.4	Default value of MANW in NVM.CTRLB is '0'.	X	X	X	X	X
NVMCTRL	High Leakage Current	1.12.5	When external reset is active, it causes a high-leakage current on VDDIO.	X	X	X	X	X
PTC	Gain Settings	1.13.1	Some gain settings for the PTC in Self-Capacitance mode do not work.	X				
PTC	WCOMP Interrupt Flag	1.13.2	WCOMP interrupt flag is not stable.	X	X	X		
PM	SysTick Timer	1.14.1	The SysTick timer does not generate a wake up signal to the Power Manager, and therefore cannot be used to wake up the CPU from Sleep mode.	X	X			

.....continued

Module	Feature	Errata Number	Summary	Affected Silicon Revisions				
				B	C	D	E	G
PM	Watchdog Reset During Debug Mode	1.14.2	In Debug mode, if a Watchdog Reset occurs, the debug session is lost.	X	X	X		
SERCOM	SPI BUFOVF Bit	1.15.1	The SERCOM SPI BUFOVF status bit is not set until the next character is received after a buffer overflow, instead of directly after the overflow has occurred.	X	X			
SERCOM	BUFOVF Flag	1.15.2	When the SERCOM is in Client SPI mode, the BUFOVF flag is not automatically cleared when CTRLB.RXEN is set to zero.	X	X			
SERCOM	SPI CTRLA Register	1.15.3	The SERCOM SPI CTRLA register bit 17 (DOPO Bit 1) will always be zero, and cannot be changed.	X	X			
SERCOM	TWI Host Mode	1.15.4	In TWI Host mode, an ongoing transaction should be stalled immediately when DBGCTRL.DBGSTOP is set and the CPU enters Debug mode.	X	X	X	X	
TC	Spurious Events	1.16.1	Spurious TC overflow and Match/Capture events may occur.	X	X	X		
TC	TC3	1.16.2	When enabled, the TC3 may not start automatically.				X	

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1. SAM D20 Errata Issues

The device variant (last letter of the ordering number) is independent of the die revision (DSU.DID.REVISION): The device variant denotes functional differences, whereas the die revision marks evolution of the die.

1.1 32.768 kHz Crystal Oscillator (XOSC32K)

1.1.1 Amplitude Control

The automatic amplitude control of the XOSC32K does not work.

Workaround

Use the XOSC32K with Automatic Amplitude control disabled (XOSC32K.AAMPEN = 0).

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.2 48 MHz Digital Frequency-Locked Loop (DFLL48M)

1.2.1 DFLL Clock

The DFLL clock must be requested before being configured otherwise a write access to a DFLL register can freeze the device.

Workaround

Write a zero to the DFLL ONDEMAND bit in the DFLLCTRL register before configuring the DFLL module.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.2.2 Calibration Bits

Changing the DFLLVAL.FINE calibration bits of the DFLL48M Digital Frequency Locked Loop might result in a short output frequency overshoot. This might occur both in Open Loop mode while writing DFLLVAL.FINE by software and Closed Loop mode when the DFLL adjusts its output frequency.

Workaround

When using DFLL48M in Open Loop mode, ensure that DFLL48M is not used by any other module while DFLLVAL.FINE is written.

When using DFLL48M in Closed Loop mode, ensure that DFLLCTRL.STABLE is written to '1'. The DFLL clock should not be used by any modules until the DFLL locks are set.

If the application requires On-the-Fly DFLL calibration (temperature/VCC drift compensation), the firmware should perform either periodically or when the DFLL48M frequency differ too much from the target frequency (indicated by DFLLVAL.DIFF), the following:

- Switch system clock/module clocks to different clock than DFLL48M
- Reinitiate a DFLL48M closed loop lock sequence by disabling and re-enabling the DFLL48M

- Wait for fine lock (PCLKSR.DFLLCKF set to 1)
- Switch back system clock/module clocks to the DFLL48M

Better accuracy is achieved using a high multiplier for the DFLL48M, using a scaled down or slow clock as reference. A multiplier of 6 will have a theoretical worst case frequency deviation from the reference clock of +/- 8.33%. A multiplier of 500 will have a theoretical worst case frequency deviation from the reference clock of +/- 0.1%.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.2.3 Firmware Writes

If the firmware writes to the DFLLMUL.MUL register in the same cycle as the Closed Loop mode tries to update it, the fine calibration will first be reset to midpoint and then incremented/decremented by the Closed Loop mode. The coarse calibration will be performed with the updated fine value. If this happens before the dfll have gotten a lock, the new fine calibration value can be between 128-DFLLMUL.FSTEP and 128+DFLLMUL.FSTEP, which could give smaller calibration range for the fine calibration.

Workaround

Always wait until the DFLL48M has locked before writing the DFLLMUL.MUL register.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.2.4 Locking Sequence

If the DFLL48M reaches the maximum or minimum COARSE or FINE calibration values during the locking sequence, an out of bounds interrupt will be generated. These interrupts will be generated even if the final calibration values at DFLL48M lock are not at maximum or minimum, and therefore might be false out-of-bounds interrupts.

Workaround

Ensure that the lockbits, DFLLCKC and DFLLCKF, in the SYSCTRL Interrupt Flag Status and Clear register (INTFLAG) are set before enabling the DFLLOOB interrupt.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.3 Analog-to-Digital Converter (ADC)

1.3.1 ADC Samples

The automatic right shift of the result when accumulating/averaging ADC samples does not work.

Workaround

To accumulate or average more than 16 samples, users must add the number of automatic right shifts to AVGCTRL.ADJRES to perform the correct number of right shifts. For example, for averaging 128 samples, AVGCTRL.ADJRES must be written to 7 instead of 4, as the automatic right shift of 3 is not done. For oversampling to 16 bits resolution, AVGCTRL.ADJRES must be written to 4 instead of 0 as the automatic right shift of 4 is not done.

The maximum number of right shifts that can be done using ADJRES is 7. This means that when averaging more than 128 samples, the result will be more than 12 bits, and the additional right shifts to get the result down to 12 bits must be done by firmware.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.3.2 Bus Clock Frequency

When the ADC bus clock frequency (CLK_ADC_APB) is smaller than the ADC asynchronous clock frequency (GCLK_ADC), issuing an ADC SWRST (ADC.CTRLA.SWRST) will lock up the ADC with the SYNCBUSY (ADC.STATUS.SYNCBUSY) flag always set.

Workaround

Do not issue an ADC SWRST if the ADC bus clock frequency (CLK_ADC_APB) is smaller than the ADC asynchronous clock frequency (GCLK_ADC).

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.4 Brown-out Detection (BOD)

1.4.1 BOD33 HYST Bit

The BOD33 HYST bit is not updated from NVM user row at power on. The reset value of this bit is zero.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.4.2 BOD12 HYST Bit

The BOD12 HYST bit is not updated from NVM user row at power on. The reset value of this bit is zero.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.4.3 Hysteresis

The BOD33 Hysteresis does not work if either an external reset or watchdog reset occurs during the time where the supply voltage is between VBOD(min) and VBOD(max). If one of those resets occur, the device will start operating if the supply voltage is below VBOD(max) but above VBOD(min) and the reset condition is lifted.

Workaround

Disable the BOD33 hysteresis (SYSCTRL.BOD33.HYST = 0), and create a virtual hysteresis by configuring:

1. The BOD33 threshold level at power on (BOD33 LEVEL) in the NVM User Row (bits 13:8) as the upper BOD threshold (VBOD(max)).
2. The SYSCTRL.BOD33.LEVEL bit field as the lower BOD threshold (VBOD(min)).

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.5 Device

1.5.1 Maximum Toggle Frequency

Maximum toggle frequency on all pins in worst case operating condition is 8 MHz. This affects all operations on the pins, including serial communications.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.5.2 APB Clock

If APB clock is stopped and GCLK clock is running, APB read access to read-synchronized registers will freeze the system. The CPU and the DAP AHB-AP are stalled, as a consequence debug operation is impossible.

Workaround

Do not make read access to read-synchronized registers when APB clock is stopped and GCLK is running. To recover from this situation, power cycle the device or reset the device using the RESET pin.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.5.3 VDDIN

When V_{DDIN} is lower than the POR threshold during power rise or fall, an internal pull-up resistor is enabled on pins with PTC functionality (see PORT Function Multiplexing). This behavior will be present even if the PTC functionality is not enabled on the pin. The POR level is defined in the “Power-On Reset (POR) Characteristics” chapter in the device data sheet.

Workaround

Use a pin without PTC functionality if the pull-up could damage your application during power up.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X				

1.5.4 Missing Bit Groups

The DFLLVAL.COARSE, DFLLVAL.FINE, DFLLMUL.CSTEP and DFLLMUL.FSTEP bit groups are not correctly located in the register map. DFLLVAL.COARSE has only 5 bits and located in DFLLVAL[12..8]. DFLLVAL.FINE has only 8 bits and located in DFLLVAL[7:0]. DFLLMUL.CSTEP has only 5 bits and located in DFLLMUL[28:24]. DFLLMUL.FSTEP has only 8 bits and located in DFLLMUL[23:16].

Workaround

DFLLVAL.COARSE, DFLLVAL.FINE, DFLLMUL.CSTEP and DFLLMUL.FSTEP should not be used if code compatibility is required with future device revisions.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.5.5 Standby Mode

With default bit and register settings, the device does not work as specified in Standby mode if load current exceeds 100 μ A.

Workaround

Set the FORCELDO bit in the VREG register.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.5.6 Temperature Sensor

The temperature sensor is not accurate. No value is written into the Temperature Log row during production test.

Workaround

None

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.5.7 External XOSC32K State

If the external XOSC32K is broken, neither the external pin RST nor the GCLK software reset can reset the GCLK generators using XOSC32K as source clock.

Workaround

Do a power cycle to reset the GCLK generators after an external XOSC32K failure.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.5.8 Voltage Regulator

The voltage regulator in Low-Power mode is not functional at temperature above 85°C.

Workaround

Enable normal mode on the voltage regulator in Standby Sleep mode.

Example code:

```
// Set the voltage regulator in normal mode configuration in standby sleep mode
SYSCTRL->VREG.bit.RUNSTDBY = 1;
```

Affected Silicon Revisions

B	C	D	E	G		
		X	X			

1.5.9 Standby Sleep Mode

Digital pin outputs from Timer/Counters, AC (Analog Comparator), GCLK (Generic Clock Controller), and SERCOM (I²C and SPI) do not change values during Standby Sleep mode.

Workaround

Set the voltage regulator in Normal mode before entering Standby Sleep mode to keep the digital pin output enabled. This is done by setting the RUNSTDBY bit in the VREG register.

Affected Silicon Revisions

B	C	D	E	G		
		X				

1.5.10 PORT Output Driver Strength Feature

The PORT output driver strength feature is not available.

Workaround

None

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.5.11 Clock Failure Detection

After a clock failure detection (INTFLAG.CFD = 1), if INTFLAG.CFD is cleared while the clock is still broken, the system is stuck.

Workaround

After a clock failure detection, do not clear INTFLAG.CFD or perform a system reset.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.5.12 Clock Failure Detection for External OSC

Clock Failure detection for external OSC does not work in Standby mode.

Workaround

Before entering Standby mode, move the CPU clock to an internal RC, disable the external OSC, and disable the Clock Failure detector. Upon CPU wake up, restart the external OSC (if it does not start, the failure occurred during Standby mode), enable the Clock Failure detector, and move the CPU clock to the external OSC.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.5.13 Digital Output Control in Standby Sleep Mode

Do not enable Timers/Counters, AC (Analog Comparator), GCLK (Generic Clock Controller), and SERCOM (I2C and SPI) to control Digital outputs in Standby Sleep mode.

Workaround

Set the voltage regulator in Normal mode before entering Standby Sleep mode. This is done by setting the RUNSTDBY bit in the VREG register.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.5.14 Invalid DFLL Calibration Values

The values stored in the NVM software calibration area for the DFLL calibration are not valid.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.5.15 Sleep Modes

In Standby, Idle1 and Idle2 Sleep modes, the device might not wake up from sleep. An External Reset, Power-On Reset, or Watchdog Reset will start the device again.

Workaround

The SLEEPFRM bits in the NVMCTRL.CTRLB register must be written to 3 (NVMCTRL - CTRLB.bit.SLEEPFRM = 3) to ensure correct operation of the device. The average power consumption of the device will increase with 20 μ A compared to values given in the Electrical Characteristics chapter of the specific device data sheet.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X				

1.5.16 Single-Shot mode at 105°C and Above

In Single-Shot mode and at 105°C and above, the ADC conversions have linearity errors.

Workarounds

- At 105°C and above, do not use the ADC in Single-Shot mode. Instead, use the ADC in Free Running mode only.
- At 105°C and above, use the ADC in Single-Shot mode only with VDDANA > 2.7V.

Affected Silicon Revisions

B	C	D	E	G		
		X	X	X		

1.5.17 I²C Client Mode

In I²C Client mode, writing the CTRLB register when in the AMATCH or DRDY interrupt service routines can cause the state machine to reset.

Workaround

Write CTRLB.ACKACT to '0' using the following sequence:

```
// If higher priority interrupts exist, then disable so that the following two writes are
atomic.
SERCOM - STATUS.reg = 0;
SERCOM - CTRLB.reg = 0;
// Re-enable interrupts if applicable.
```

Write CTRLB.ACKACT to '1' using the following sequence:

```
SERCOM - CTRLB.reg = SERCOM_I2CS_CTRLB_ACKACT;
```

Otherwise, write to CTRLB in the AMATCH or DRDY interrupts if it is to close out a transaction.

When not closing a transaction, clear the AMATCH interrupt by writing a '1' to its bit position instead of using CTRLB.CMD. The DRDY interrupt is automatically cleared by reading/writing to the DATA register in smart mode. If not in smart mode, DRDY should be cleared by writing a '1' to its bit position.

Code replacements examples:

Current:

```
SERCOM - CTRLB.reg |= SERCOM_I2CS_CTRLB_ACKACT;
```

Change to:

```
SERCOM - STATUS.reg = 0;
SERCOM - CTRLB.reg = SERCOM_I2CS_CTRLB_ACKACT;
SERCOM - CTRLB.reg &= ~SERCOM_I2CS_CTRLB_ACKACT;
SERCOM - CTRLB.reg = 0;
/* ACK or NACK address */
SERCOM - CTRLB.reg |= SERCOM_I2CS_CTRLB_CMD(0x3);
// CMD=0x3 clears all interrupts, so to keep the result similar,
// PREC is cleared if it was set.
if (SERCOM - INTFLAG.bit.PREC) SERCOM - INTFLAG.reg = SERCOM_I2CS_INTFLAG_PREC;
SERCOM - INTFLAG.reg = SERCOM_I2CS_INTFLAG_AMATCH;
```

Affected Silicon Revisions

B	C	D	E	G		
		X	X			

1.5.18 NVM User Row Mapping

In the table "NVM User Row Mapping", bits 40 and 41 default values on silicon are not as specified in the device data sheet. The data sheet defines the default value as '0'; however, it is '1' for both bits on silicon.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
		X	X	X		

1.5.19 WDT Window Bits

In the table "NVM User Row Mapping", the WDT Window bit field default value on silicon is not as specified in the device data sheet. The device data sheet defines the default value as '0x5' while it is '0xB' on silicon.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.5.20 Incorrect SYSTICK Calibration Value

The SYSTICK calibration value is incorrect.

Workaround

The correct SYSTICK calibration value is 0x40000000. This value should not be used to initialize the SysTick RELOAD value register, which should be initialized instead with a value depending on the main clock frequency and on the tick period required by the application. For a detailed description of the SYSTICK module, refer to the ARM Cortex-M0+ documentation.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.5.21 Potential lockup on standby entry

When the SYSTICK interrupt is enabled, a device lockup can occur upon standby entry in the rare occasion when the SYSTICK interrupt coincides with the standby entry.

Workaround

Disable the SYSTICK interrupt before entering standby and re-enable it after.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.6 Device Service Unit (DSU)

1.6.1 Debugging

If a debugger has issued a DSU Cold-Plugging procedure and then released the CPU from the resulting "CPU Reset Extension", the CPU will be held in "CPU Reset Extension" after any upcoming reset event.

Workaround

The CPU must be released from the "CPU Reset Extension" either by writing a one in the DSU STATUSA.CRSTEXT register or by applying an external reset with SWCLK high or by power cycling the device.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X				

1.6.2 Non-functional MBIST "Pause-on-Error" Feature

The MBIST "Pause-on-Error" feature is not functional on this device.

Workaround

Do not use the "Pause-on-Error" feature.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.7 Digital-to-Analog Converter (DAC)

1.7.1 Standby Sleep Mode

When DAC.CTRLA.RUNSTDBY = 0 and DATABUF is written (not empty), if the device goes to Standby Sleep mode before a Start Conversion event, DAC.INTFLAG.EMPTY will be set after exit from Sleep mode.

Workaround

After waking from Standby mode, ignore and clear the flag DAC.INTFLAG.EMPTY.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.8 External Interrupt Controller (EIC)

1.8.1 Edge Configuration

When the EIC is configured to generate an interrupt on a low level or rising edge or both edges (CONFIGn.SENSEx) with the filter enabled (CONFIGn.FILTENx), a spurious flag might appear for the dedicated pin on the INTFLAG.EXTINT[x] register as soon as the EIC is enabled using the CTRLA ENABLE bit.

Workaround

Clear the INTFLAG bit once the EIC is enabled and before enabling the interrupts.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.9 Event System (EVSYS)

1.9.1 Channel Generator Change

Changing the selected generator of a channel can trigger a spurious interrupt/event.

Workaround

To change the generator of a channel, first write with EDGESEL written to zero, then perform a second write with EDGESEL written to its target value.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.9.2 Overrun Condition

Using synchronous or resynchronized paths, some channels (0,3,6,7) detect an overrun on every event even if no overrun condition is present.

Workaround

Ignore overrun detection bit for channels 0,3,6,7 and use channels 1,2,4,5 if overrun detection is required.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.10 General Clock (GCLK)

1.10.1 GCLK Lock State

When a GCLK is locked and the generator used by the locked GCLK is not GCLK generator 1, issuing a GCLK software reset will lock up the GCLK with the SYNCBUSY flag always set.

Workaround

Do not issue a GCLK SWRST or map GCLK generator 1 to ""locked"" GCLKs.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.10.2 Division Factor

The GCLK Generator clock is stuck when disabling the generator and changing the division factor from '1' to a different value while the GCLK generator is set as output. When the GCLK generator is enabled (GENCTRL.GENEN=1), set as output (GENCTRL.OE = 1) and use a division factor of one (GENDIV.DIV = 1 or 0 and GENCTRL.DIVSEL = 0), if the division factor is written to a value different of '1' or '0' after disabling the GCLK generator (GENCTRL.GENEN=0), the GCLK generator will be stuck.

Workaround

Disable the OE request of the GCLK generator (GENCTRL.OE=0) before disabling the GCLK generator (GENCTRL.GENEN=0).

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.10.3 Division Factor

When the GCLK generator is enabled (GENCTRL.GENEN = 1), set as output (GENCTRL.OE = 1) and use a division factor of one (GENDIV.DIV = 1 or 0 and GENCTRL.DIVSEL=0), the GCLK_IO might not be set to the configured GENCTRL.OOV value after disabling the GCLK generator (GENCTRL.GENEN=0).

Workaround

Disable the OE request of the GCLK generator (GENCTRL.OE = 0) before disabling the GCLK generator (GENCTRL.GENEN = 0).

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.11 I/O Pin Controller (PORT)

1.11.1 PORT Read and Write

PORT read/write attempts on non-implemented registers, including addresses beyond the last implemented register group (PA, PB,...), do not generate a PAC protection error.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		

X	X	X	X	X		
---	---	---	---	---	--	--

1.12 Non-Volatile Memory Controller (NVMCTRL)

1.12.1 Erase or Write

When NVMCTRL issues either erase or write commands and the NVMCTRL cache is not in LOW_POWER mode, CPU hardfault exception may occur.

Workaround

Either turn off cache before issuing Flash commands, by setting the NVMCTRL CTRLB.CACHEDIS bit to '1', or configure the cache in LOW_POWER mode by writing '0x1' into the NVMCTRL CTRLB.READMODE bit.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.12.2 Cache Read Mode

When Cache Read mode is set to deterministic (READMODE=2), setting CACHEDIS=1 does not lead to 0 wait states on Flash access.

Workaround

When disabling the cache (CTRLB.CACHEDIS=1), the user must also set READMODE to 0 (CTRLB.READMODE=0).

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.12.3 EEPROM Emulation Area Configuration

When the device is secured and EEPROM emulation area configured to none, the CRC32 is not executed on the entire Flash area but up to the on-chip Flash size minus half a row.

Workaround

When using CRC32 on a protected device with EEPROM emulation area configured to none, compute the reference CRC32 value to the full chip Flash size minus half row.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X				

1.12.4 Default MANW Value

Default value of MANW in NVM.CTRLB is 0.

Workaround

This can lead to spurious writes to the NVM if a data write is done through a pointer with a wrong address corresponding to NVM area.

Set MANW in the NVM.CTRLB to 1 at startup.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.12.5 High Leakage Current

When external reset is active, it causes a high leakage current on VDDIO.

Workaround

Minimize the time external reset is active.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X	X		

1.13 Peripheral Touch Controller (PTC)

1.13.1 Gain Settings

Some gain settings for the PTC in self-capacitance mode do not work. The two lowest gain settings are not selectable and an attempt by the QTouch Library to set enable of these may result in a higher sensitivity than optimal for the sensor. The PTC will not detect all touches. This errata does not affect mutual-capacitance mode which operates as specified.

Workaround

Use SAM D20 revision C or later for self-capacitance touch sensing.

Affected Silicon Revisions

B	C	D	E	G		
X						

1.13.2 WCOMP Interrupt Flag

WCOMP interrupt flag is not stable. The WCOMP interrupt flag will not always be set as described in the data sheet.

Workaround

Do not use the WCOMP interrupt instead use the WCOMP event.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X				

1.14 Power Manager (PM)

1.14.1 SysTick Timer

The SysTick timer does not generate a wake up signal to the Power Manager, and therefore cannot be used to wake up the CPU from Sleep mode.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.14.2 Watchdog Reset During Debug Mode

In Debug mode, if a Watchdog Reset occurs, the debug session is lost.

Workaround

A new debug session must be restart after a Watchdog Reset.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X				

1.15 Serial Communication Interface (SERCOM)

1.15.1 SPI BUFOVF Bit

The SERCOM SPI BUFOVF status bit is not set until the next character is received after a buffer overflow, instead of directly after the overflow has occurred. In addition, the CTRLA.IBON bit will always be zero and cannot be changed.

Workaround

None.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.15.2 BUFOVF Flag

When the SERCOM is in Client SPI mode, the BUFOVF flag is not automatically cleared when CTRLB.RXEN is set to zero.

Workaround

The BUFOVF flag must be manually cleared by software.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.15.3 SPI CTRLA Register

The SERCOM SPI CTRLA register bit 17 (DOPO Bit 1) will always be zero, and cannot be changed. Therefore, the SERCOM SPI cannot be switched between Host and Client mode on the same DI and DO pins.

Workaround

Connect the alternate DI and DO pins externally and use the port MUX to switch between pin configurations for Host and Client functionality.

Affected Silicon Revisions

B	C	D	E	G		
X	X					

1.15.4 TWI Host Mode

In TWI Host mode, an ongoing transaction should be stalled immediately when DBGCTRL.DBGSTOP is set and the CPU enters debug mode. Instead, it is stopped when the current byte transaction is completed and the corresponding interrupt is triggered if enabled.

Workaround

In TWI Host mode, keep DBGCTRL.DBGSTOP=0 when in debug mode.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X	X			

1.16 Timer/Counter (TC)

1.16.1 Spurious Events

Spurious TC overflow and Match/Capture events may occur.

Workaround

Do not use the TC overflow and Match/Capture events. Use the corresponding Interrupts instead.

Affected Silicon Revisions

B	C	D	E	G		
X	X	X				

1.16.2 TC3

When enabled, the TC3 may not start automatically.

Workaround

After TC3 has been enabled, the TC3 must be retrigged by software (using command TC_CTRLBSET_CMD_RETRIGGER in register CTRLBSET[7:6]). This ensures that TC3 starts in any case.

Affected Silicon Revisions

B	C	D	E	G		
			X			

2. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the revision "F" of the device data sheet (DS60001504F).

Note: Corrections in tables, registers, and text are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

2.1 SERCOM-I²C Client SDAHOLD

For Device Variant A, the CTRLA.SDAHOLD timing of the SERCOM I²C when operating in Client mode has been updated.

Table 2-1. Hold Time

Value	Name	Device Variant A	Device Variant A
0x0	DIS	Disabled	Disabled
0x1	75	5-50 ns	5-100 ns
0x2	450	70-250 ns	300-600 ns
0x3	600	100-350 ns	400-800 ns

3. Appendix A: Revision History

Rev A Document (8/2017)

Initial release of this document.

Rev B Document (12/2017)

Updated the Data Sheet revision from A to B.

Rev C Document (12/2019)

Updated Data Sheet revision from B to D.

Added a new [Errata Summary](#) Table.

Updated the Device ID Numbers in the following tables:

- [SAM D20 Family Silicon Device Identification \(Device Variant A\)](#)
- [SAM D20 Family Silicon Device Identification \(Device Variant B\)](#)

Rev D Document (11/2020)

Added a new Errata: Potential Lockup on Standby Entry

Updated the Data Sheet Revision letter.

Updated the [Data Sheet Clarifications](#) section with the following clarifications:

- WDT Window Default Value in NVM User Row
- NVMCTRL LOCK Register
- ADC Wake-up Interrupts
- DAC Maximum Input Clock Frequency for SAM D20 at 85°C and 105°C
- DAC Chapter Updates
- Junction Temperature for SAM D20 at 105°C
- Moisture Sensitivity Level
- Power Supply Schematic

Rev E Document (11/2021)

The SPI and I²C standards use the terminology "Master" and "Slave". The equivalent Microchip terminology, "Host" and "Client", is used in this document. This terminology has been updated throughout this document for this revision.

Added the following two errata issues:

- [BOD: 1.4.3 Hysteresis](#)

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